

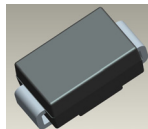
## Features

- Ultra Low Forward Voltage Drop
- Excellent High Temperature Capability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 175°C Operating Junction Temperature
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

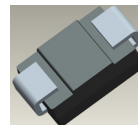
## Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (approximate)

SMA



Top View



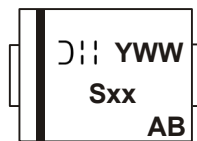
Bottom View

## Ordering Information (Note 4)

Part Number	Case	Packaging
SBR2U150SA-13	SMA	5000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



S D B or S Q B = Product Type Marking Code  
 ⌋⌋ = Manufacturers' code marking  
 YWW = Date Code Marking  
 Y = Last digit of year (ex: 9 for 2009)  
 WW = Week code (01 – 53)  
 AB = Foundry and Assembly Code

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	150	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_{RM}$		
Average Rectified Output Current (See Figure 1)	$I_O$	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	42	A
Maximum Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10,000	V/ $\mu\text{s}$

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Soldering (Note 4)	$R_{\theta JS}$	3	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	119	
Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	88	
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +175	$^\circ\text{C}$

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	150	—	—	V	$I_R = 100\mu\text{A}$
Forward Voltage Drop	$V_F$	—	—	0.8	V	$I_F = 2.0\text{A}, T_J = +25^\circ\text{C}$
		—	—	0.65		$I_F = 2.0\text{A}, T_J = +125^\circ\text{C}$
Leakage Current (Note 6)	$I_R$	—	—	75	$\mu\text{A}$	$V_R = 150\text{V}, T_J = +25^\circ\text{C}$
		—	—	10	mA	$V_R = 150\text{V}, T_J = +125^\circ\text{C}$

- Notes:
- Theoretical  $R_{\theta JS}$  calculated from the top center of the die straight down to the PCB cathode tab solder junction.
  - FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.  $T_A = 25^\circ\text{C}$
  - Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>
  - Short duration pulse test used to minimize self-heating effect.

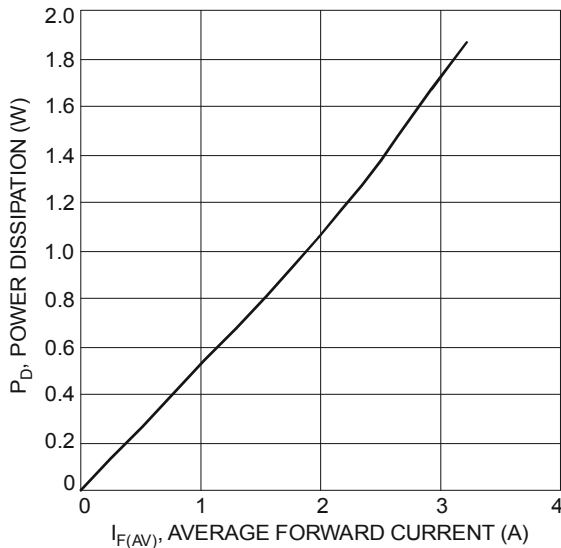


Fig. 1 Forward Power Dissipation

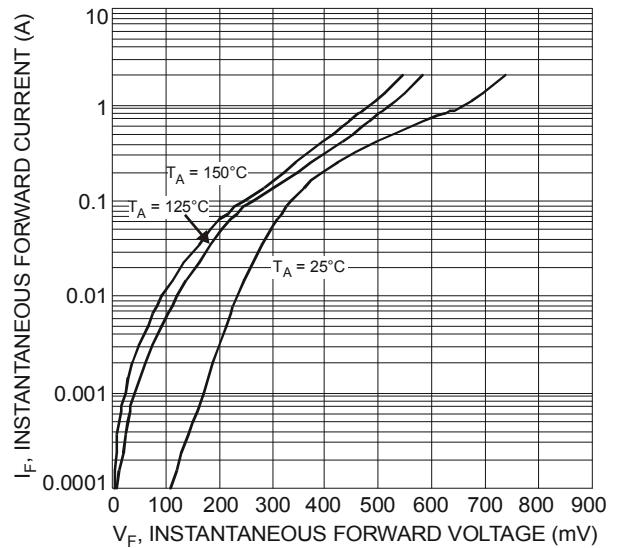


Fig. 2 Typical Forward Characteristics

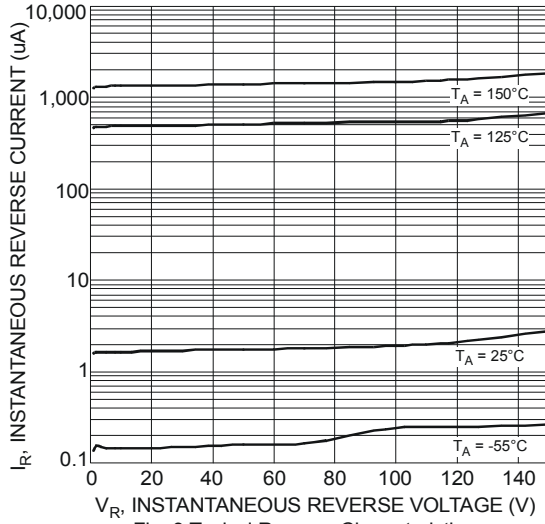


Fig. 3 Typical Reverse Characteristics

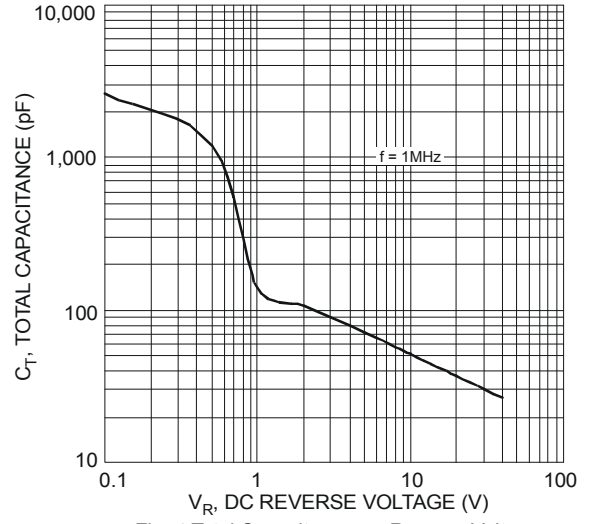


Fig. 4 Total Capacitance vs. Reverse Voltage

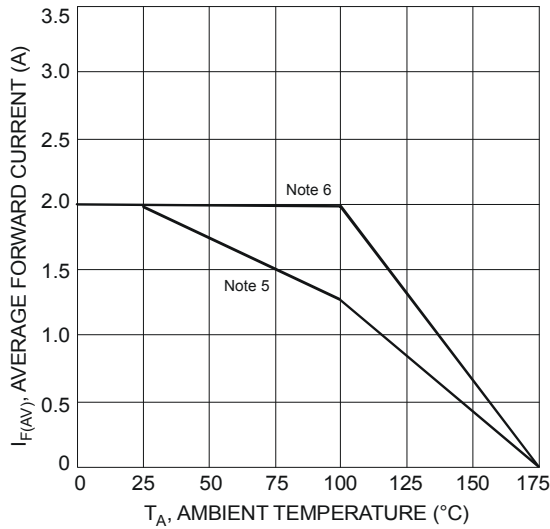


Fig. 5 DC Forward Current Derating Curve

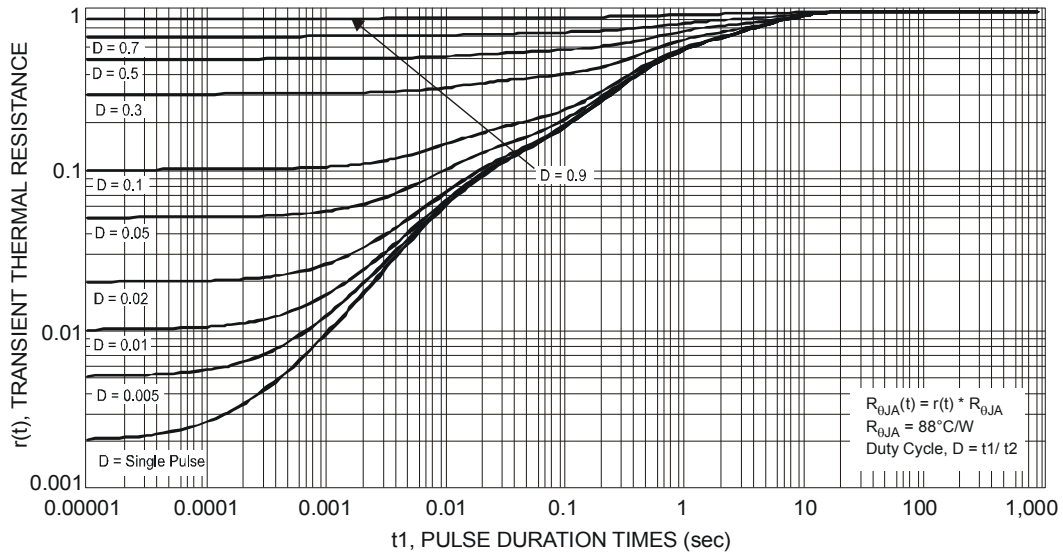
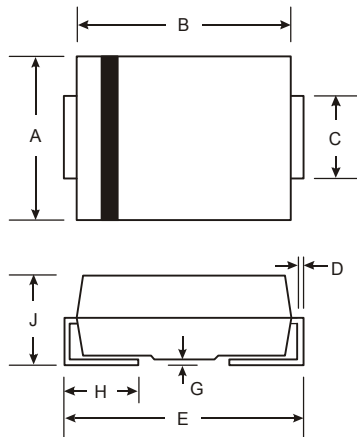


Fig. 6 Transient Thermal Resistance

## Package Outline Dimensions

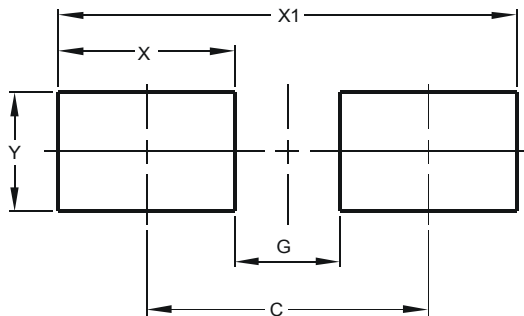
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	2.01	2.30
<b>All Dimensions in mm</b>		

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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